

## Features

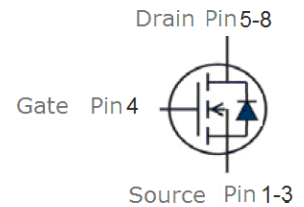
- N-Channel
- Enhancement mode
- Very low on-resistance  $R_{DS(on)}$  @  $V_{GS}=4.5\text{ V}$
- Fast Switching
- High conversion efficiency
- Pb-free lead plating; RoHS compliant



$V_{DS}$	55	V
$R_{DS(on),TYP}$ @ $V_{GS}=4.5\text{ V}$	12	m $\Omega$
$I_D$	12	A



Part ID	Package Type	Marking	Tape and reel information
VS6016AS	SOP8	6016AS	3000pcs/reel



## Maximum ratings, at $T_j=25\text{ }^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	55	V
$I_S$	Diode continuous forward current	$T_C=25^\circ\text{C}$ 12	A
$I_D$	Continuous drain current @ $V_{GS}=10\text{V}$	$T_C=25^\circ\text{C}$ 12	A
		$T_C=70^\circ\text{C}$ 8	A
$I_{DM}$	Pulse drain current tested ①	$T_C=25^\circ\text{C}$ 48	A
EAS	Avalanche energy, single pulsed ②	$I_D=40\text{A}$ 80	mJ
IAS	Avalanche energy, single pulsed ②	40	A
$P_D$	Maximum power dissipation	$T_C=25^\circ\text{C}$ 2.0	W
$V_{GS}$	Gate-Source voltage	$\pm 20$	V
$T_{STG} T_J$	Storage and operating temperature range	-55 to 175	$^\circ\text{C}$

## Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	20	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	72	$^\circ\text{C/W}$

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	55	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current(T <sub>c</sub> =25°C)	V <sub>DS</sub> =48V, V <sub>GS</sub> =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T <sub>c</sub> =125°C)	V <sub>DS</sub> =48V, V <sub>GS</sub> =0V	--	--	100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.6	2.5	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =8A	--	11	14	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A	--	12	16	mΩ
<b>Dynamic Electrical Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	--	2250	--	pF
C <sub>oss</sub>	Output Capacitance		--	220	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	165	--	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =25V, I <sub>D</sub> =4A, V <sub>GS</sub> =10V	--	58	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	5.9	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	14.5	--	nC
R <sub>g</sub>	Gate Resistance	V <sub>GS</sub> =0V, f=1MHz	--	1.2	--	Ω
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =25V, I <sub>D</sub> =4A, R <sub>G</sub> =6.8Ω, V <sub>GS</sub> =10V	--	20	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	98	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	46	--	nS
t <sub>f</sub>	Turn-Off Fall Time		--	91	--	nS
<b>Source- Drain Diode Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
V <sub>SD</sub>	Forward on voltage	I <sub>SD</sub> =8A, V <sub>GS</sub> =0V	--	0.78	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>j</sub> =25°C, I <sub>sd</sub> =4A, V <sub>GS</sub> =0V	--	20	--	nS
Q <sub>rr</sub>	Reverse Recovery Charge	di/dt=100A/μs		13		nC

**NOTE:**

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T<sub>Jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.1mH, R<sub>G</sub> = 25Ω, I<sub>AS</sub> = 40A, V<sub>GS</sub> = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

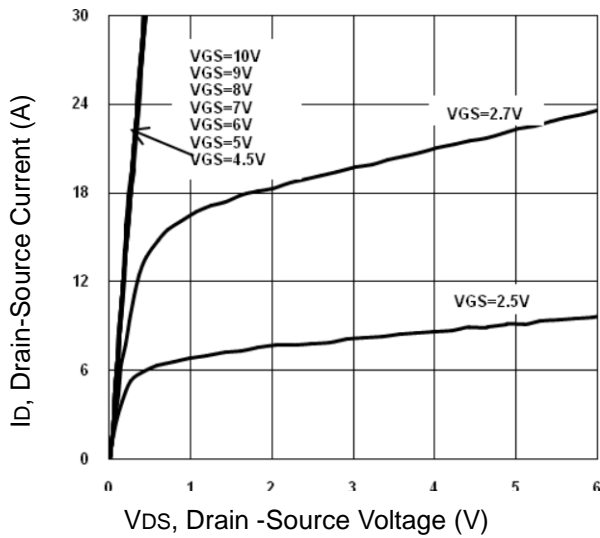


Fig1. Typical Output Characteristics

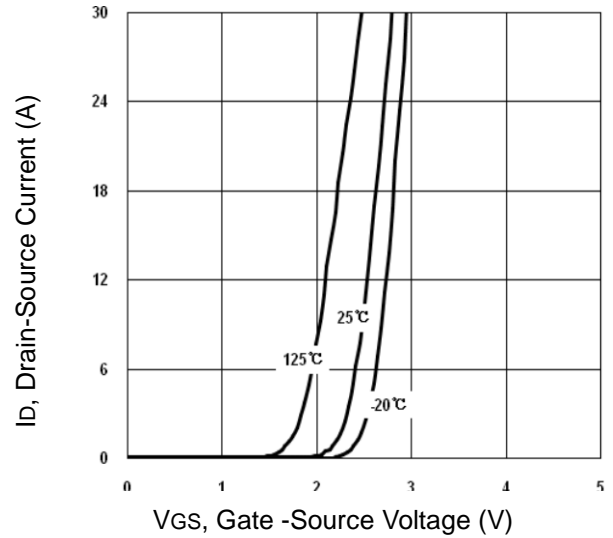


Fig2. Typical Transfer Characteristics

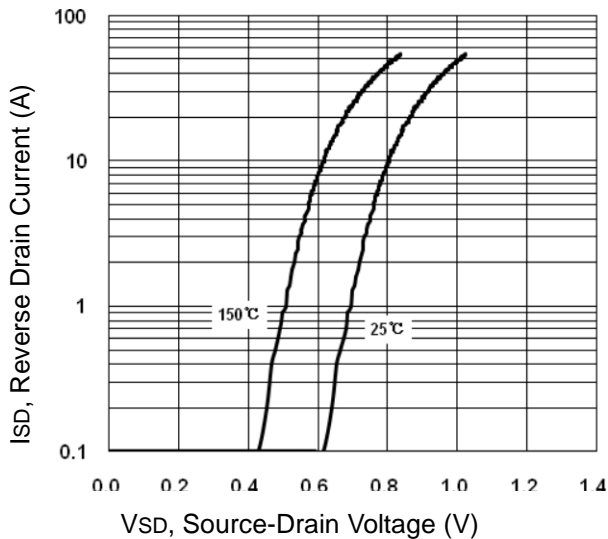


Fig3. Typical Source-Drain Diode Forward

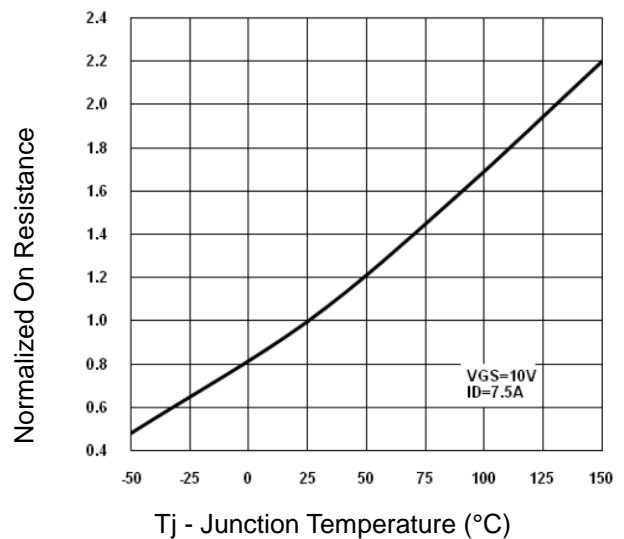


Fig4. Normalized On-Resistance Vs. Temperature

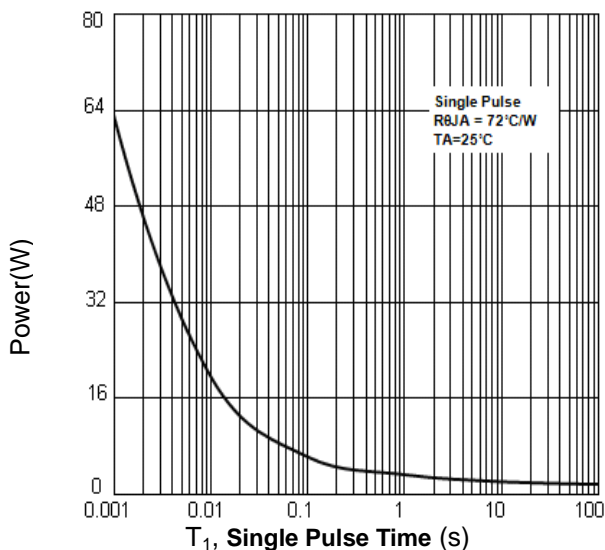


Fig5. Single Pulse Maximum Power Dissipation

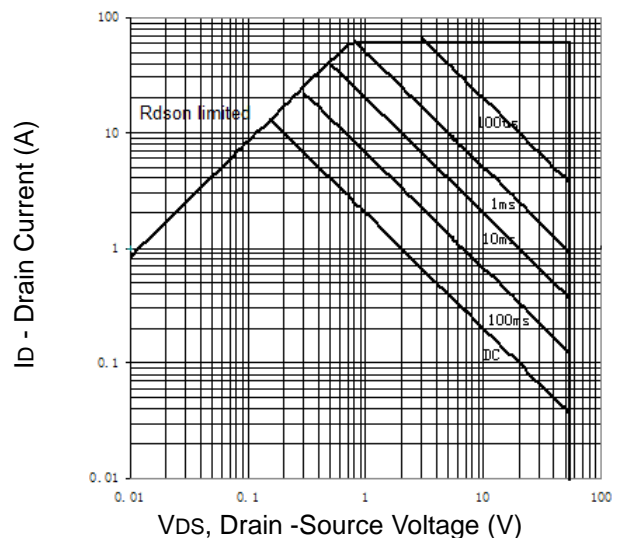
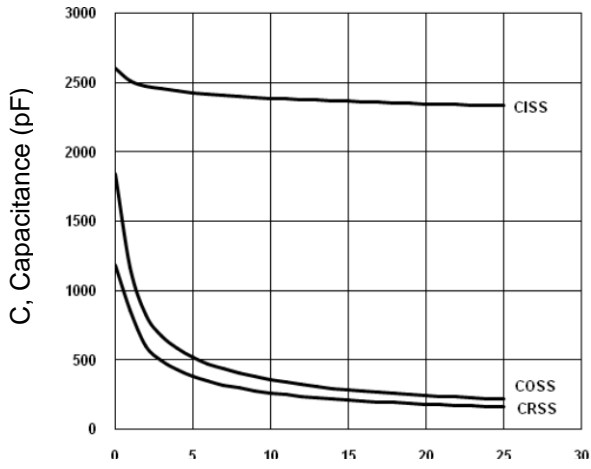
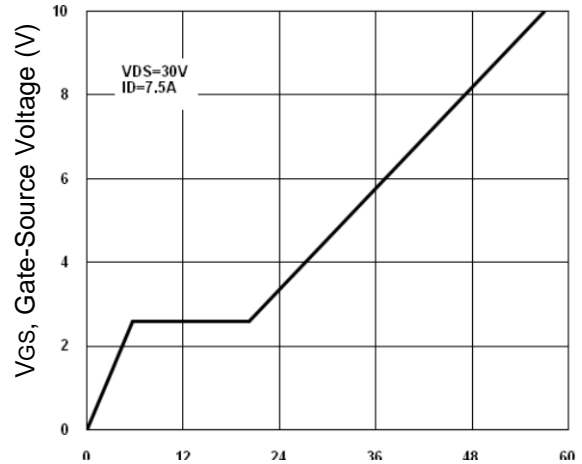


Fig6. Maximum Safe Operating Area



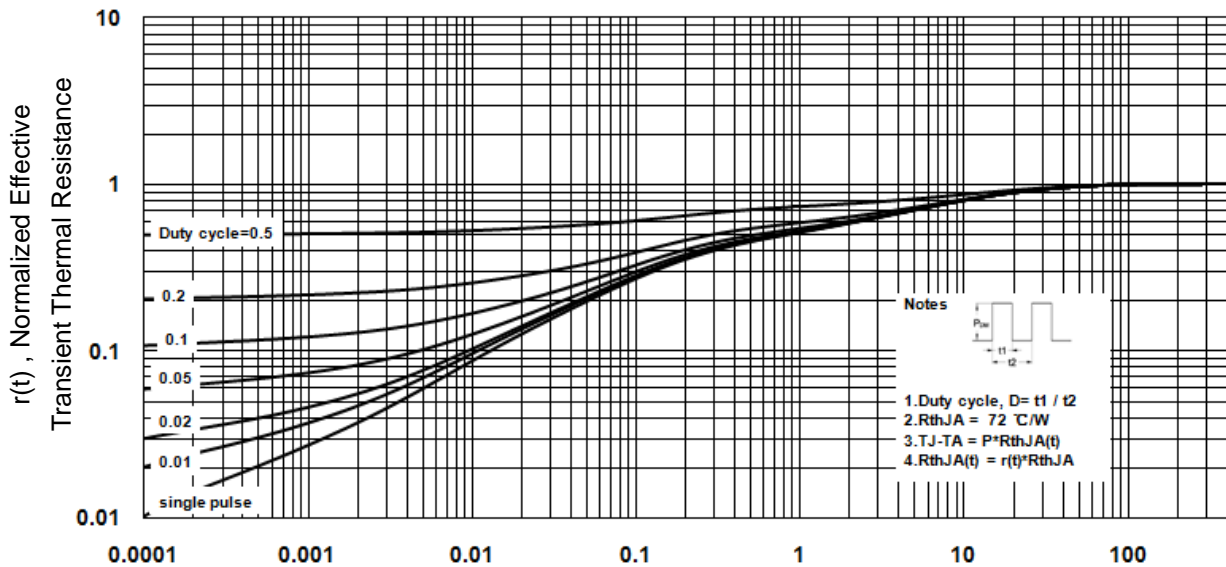
VDS , Drain-Source Voltage (V)

Fig7. Typical Capacitance Vs.Drain-Source Voltage



Qg -Total Gate Charge (nC)

Fig8. Typical Gate Charge Vs.Gate-Source Voltage



T1, Square Wave Pulse Duration(sec)

Fig9. T1 ,Transient Thermal Response Curve

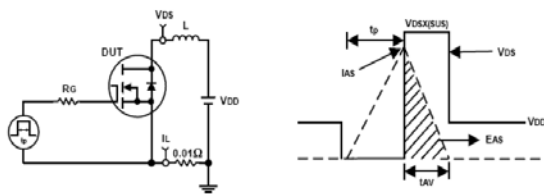


Fig10. Unclamped Inductive Test Circuit and waveforms

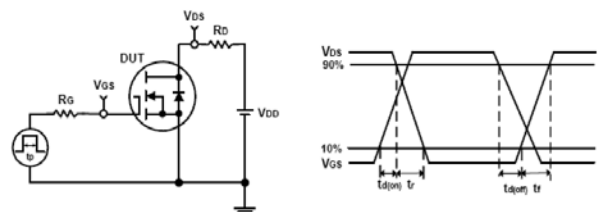
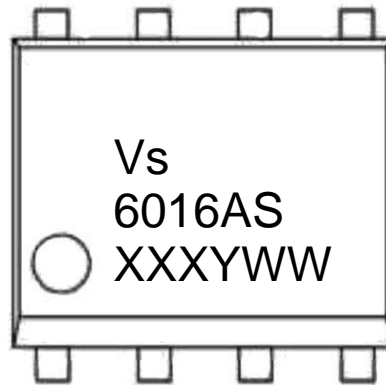


Fig11. Switching Time Test Circuit and waveforms



## Marking Information



1<sup>st</sup> line: Company Code (Vs), Company Logo

2<sup>nd</sup> line: Part Number (6016AS)

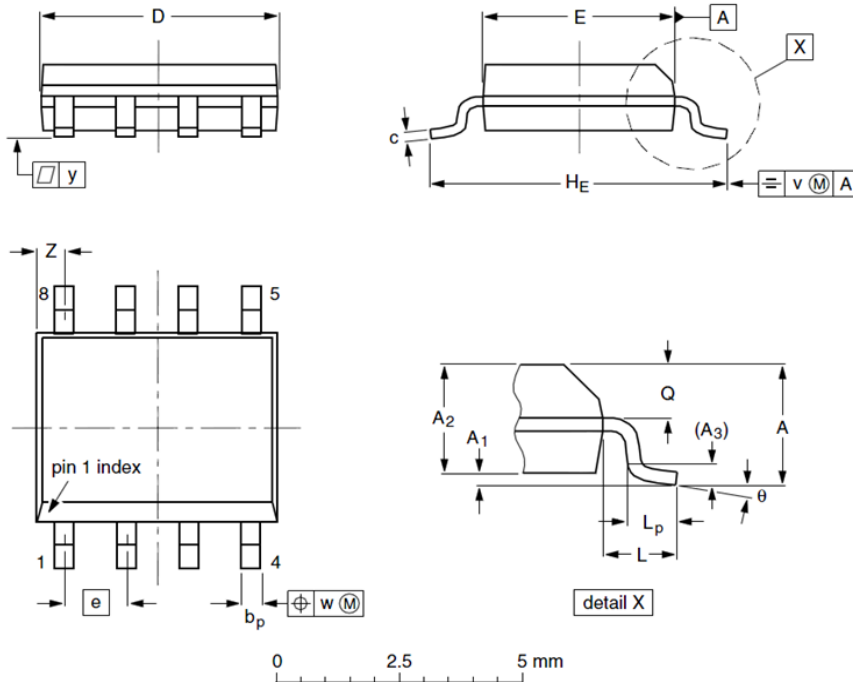
3<sup>rd</sup> line: Date code (XXXYWW)

XXX: Wafer Lot Number

Y: Year Code, e.g. E means 2017

WW: Week Code

### SOP8 Package Outline Data



Label	Dimensions (unit: mm)		
	Min	Typ	Max
A	--	--	1.75
A <sub>1</sub>	0.10	0.18	0.25
A <sub>2</sub>	1.25	1.35	1.50
A <sub>3</sub>	--	0.25	--
b <sub>p</sub>	0.36	0.42	0.51
c	0.19	0.22	0.25
D	4.80	4.92	5.00
E	3.80	3.90	4.00
e	--	1.27	--
H <sub>E</sub>	5.80	6.00	6.20
L	--	1.05	--
L <sub>p</sub>	0.40	0.68	1.00
Q	0.60	0.65	0.725
v	--	0.25	--
w	--	0.25	--
y	--	0.10	--
Z	0.30	0.50	0.70
$\theta$	0°		8°

**Notes:**

1. Follow JEDEC MS-012.
2. Dimension "D" does NOT include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15mm per side.
3. Dimension "E" does NOT include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25mm per side.
4. Dimension "b<sub>p</sub>" does NOT include dambar protrusion. Allowable dambar protrusion shall be 0.1mm total in excess of "b<sub>p</sub>" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.

## Customer Service

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